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Vishay Siliconix



PRODUCT SUMMARY				
V _{DS} (V)	40			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.00179			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.00236			
Q _g typ. (nC)	130			
I _D (A)	150 ^d			
Configuration	Single			

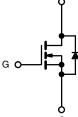
FEATURES

N-Channel 40 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- Maximum 175 °C junction temperature
- Excellent R_{DS}-Q_g and R_{DS}-Q_{oss} FOM reduce power loss from conduction and switching to enable high efficiency
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Power supply
 Secondary synchronous rectification
- DC/DC converter
- Power tools
- Motor drive switch
- Battery management



RoHS

D

N-Channel MOSFET

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free and halogen-free	SUP40012EL-GE3

ABSOLUTE MAXIMUM RATING	S (T _C = 25 °C, unle	ss otherwise note	d)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	40	v	
Gate-source voltage		V _{GS}	± 20		
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		150 ^d		
	T _C = 70 °C	I _D	150 ^d	•	
Pulsed drain current (t = 100 µs)		I _{DM}	300	A	
Avalanche current		I _{AS}	50		
Single avalanche energy ^a L = 0.1 mH		E _{AS}	125	mJ	
Maximum power dissipation ^a	T _C = 25 °C	D	150 ^b	W	
	T _C = 125 °C	P _D	50 ^b	vv	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-ambient (PCB mount) ^c	R _{thJA}	40	°C/W
Junction-to-case (drain)	R _{thJC}	1	0/10

Notes

a. Duty cycle \leq 1 %

b. See SOA curve for voltage derating

c. When mounted on 1" square PCB (FR4 material)

d. Package limited

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			1			
Drain-source breakdown voltage	V _{DS}	V_{GS} = 0 V, I_D = 250 μ A	40	-	-	
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	-	2.5	- V
Gate-body leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 250	nA
Zero gate voltage drain current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA
	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	150	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	5	mA
On-state drain current ^a	I _{D(on)}	$V_{DS} \! \geq \! 10 \text{ V}, \text{V}_{GS} \! = \! 10 \text{ V}$	120	-	-	А
	_	$V_{GS} = 10 \text{ V}, I_{D} = 30 \text{ A}$	-	0.00149	0.00179	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.00196	0.00236	Ω
Forward transconductance ^a	g _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 30 \text{ A}$	-	230	-	S
Dynamic ^b			1		I	
Input capacitance	C _{iss}		-	10 930	-	
Output capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 20 V, f = 1 MHz	-	2041	-	pF
Reverse transfer capacitance	C _{rss}		-	101	-	
Total gate charge ^c	Qg		-	130	195	
Gate-source charge ^c	Q _{gs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	33.6	-	_
Gate-drain charge ^c	Q _{gd}		-	6.7	-	nC
Output charge	Q _{oss}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	64	96	
Gate resistance	Rg	f = 1 MHz	0.36	1.8	3.6	Ω
Turn-on delay time ^c	t _{d(on)}		-	25	50	
Rise time ^c	tr	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 2 \Omega$	-	12	24	
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{ R}_g = 1 \Omega$	-	65	130	ns
Fall time ^c	t _f		-	18	36	
Drain-Source Body Diode Ratings	and Characte	ristics ^b (T _C = 25 °C)	L	•	11	
Pulsed current (t = 100 µs)	I _{SM}		-	-	300	А
Forward voltage ^a	V _{SD}	$I_{F} = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.8	1.5	V
Reverse recovery time	t _{rr}		-	58	116	ns
Peak reverse recovery charge	I _{RM(REC)}		-	2.1	4.2	А
Reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/µs	-	72	144	nC
Reverse recovery fall time	t _a		-	32	-	
Reverse recovery rise time	t _b		-	26	-	ns

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},~\text{duty~cycle} \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

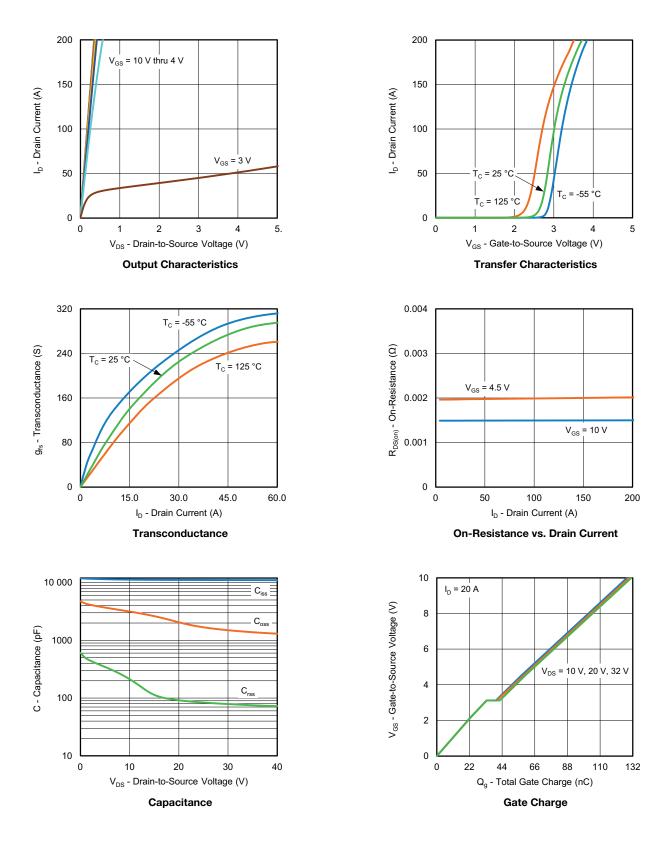
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



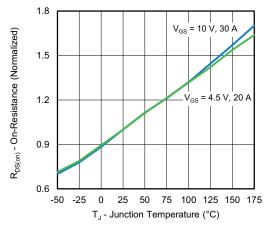
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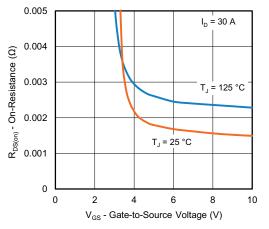


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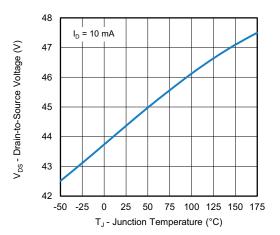
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



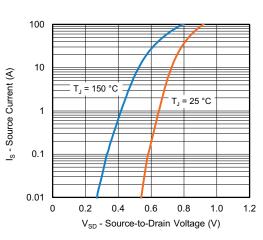
On-Resistance vs. Junction Temperature



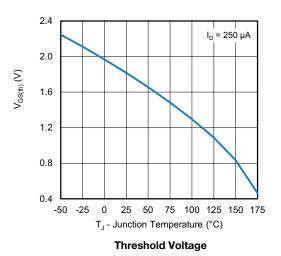
On-Resistance vs. Gate-to-Source Voltage

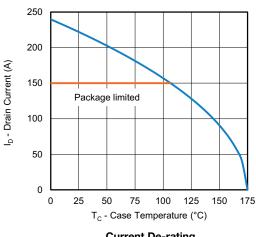


Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage





Current De-rating

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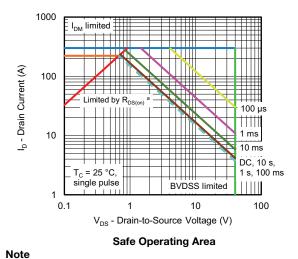
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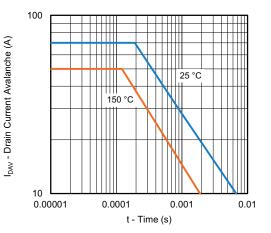
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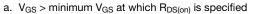
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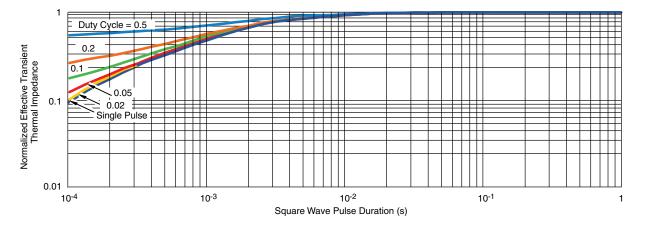
THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)





Single Pulse Avalanche Current Capability vs. Time







Note

· The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual pplication parameters and operating conditions

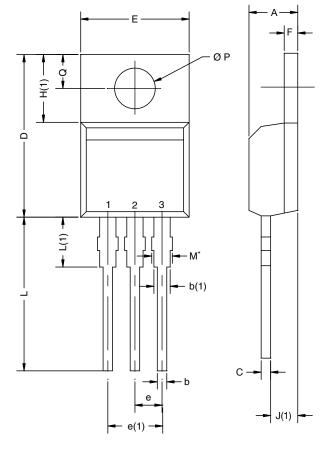
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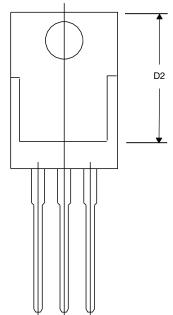
TO-220AB



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
D2	12.19	12.70	0.480	0.500
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØР	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
ECN: T14-0 DWG: 5471	0413-Rev. P, 1	16-Jun-14	•	•

Note

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



Revison: 16-Jun-14

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